

• HIGH SENSITIVITY, LOW-PRESSURE SILICON DIE

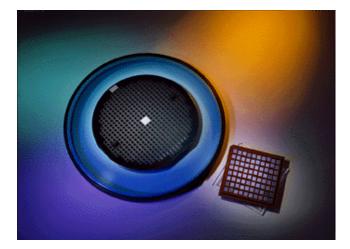
DESCRIPTION

The SM5103 is a silicon micro-machined, piezoresistive low pressure sensing chip. These devices are available in full-scale ranges from 0.3 to 3.0 psi and are ideal for OEM and high volume applications.

Provided in die form, these sensors can be mounted on ceramic or PC board substrates as part of an OEM system. They also may be packaged into proprietary or applicationspecified sensor lines.

Die are probed, inked and diced, and shipped on tape.

Custom pressure ranges available in high-volume applications.



FEATURES

- Low Pressure (from 0-0.3 to 0-3.0 PSI)
- High Performance at Low Pressures
- Constant Current or Constant Voltage
 Drive
- High Volume, Low Cost
- High Millivolt Output

APPLICATIONS

- Air Flow
- Level Detection
- HVAC
- Instrumentation
- Gas Analysis



CHARACTERISTICS FOR SM5103 - SPECIFICATIONS

All parameters are measured at 5.000V supply at room temperature, unless otherwise specified.

	Min.	Тур.	Max.	Units	Notes
Excitation Voltage	0	5.0	10.0	V	1
Excitation Current	0	1.5	3.0	mA	1
Span (FS Range)					2
0.3 PSI	25	50	75	mV	
0.8 PSI	25	50	75	mV	
1.5 PSI	25	50	75	mV	
3.0 PSI	25	50	75	mV	
Offset	-75	0	25	mV	
TC Span	-24	-19	-15.5	%FS/100°C	3
TC Offset	-7	-1	+7	%FS/100°C	3
TC Resistance	24	27.5	33	%/100°C	
Linearity	-0.3	<u>+</u> 0.1	0.3	%FS	4
Bridge Impedance	2.7	3.3	4.0	kΩ	
Proof Pressure	10X			Rated FS	
Burst Pressure	15X			Rated FS	5
Operating Temperature	-40		125	С°	
Storage Temperature	-55		150	O°	

Notes:

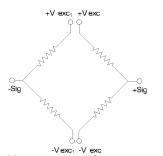
1. Bridge may be driven with positive or negative excitation as long as Vsub is not connected. SMI does recommend connecting the Vsub to the highest voltage in the bridge for added offset stability.

2. Measured at 5V constant voltage excitation.

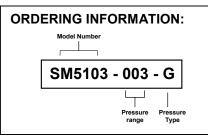
3. Measured from 0 to 70 C

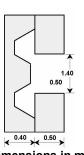
4. Defined as best straight line; 0.3 PSI linearity is ± 0.5% FS (max).

5. Burst Pressure is the pressure where the part can survive the overpressure but may degrade over repeated cycles.



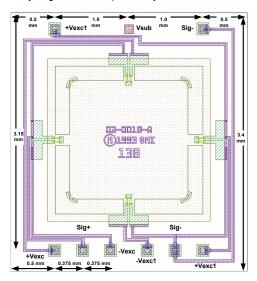
Positive output for pressure applied to the top (circuit) side of the sensor





Die dimensions in mm

Pressure Ranges						
	PSI	5103				
	0.3	003				
	0.8	008				
	1.5	015				
	3.0	030				
Gage only.						
Custom ranges available						
in high volumes						



SM5103 Die (3.4X3.2 mm as sawn) Covered under USA Mask-Copyright See separate Application Notes for typical range of variation in Saw dimensions.

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